**COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.**  
**ASSEMBLY VARIANT: 001**

<table>
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<th>PCB VIEWED FROM BOTTOM SIDE</th>
<th>BOARD #: PMP10936</th>
<th>REV: C</th>
<th>SUN REV: Not In VersionControl</th>
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<td>PLOT NAME = Bottom Assembly Drawing</td>
<td>GENERATED : 7/25/2015 8:55:57 PM</td>
<td>TEXAS INSTRUMENTS</td>
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